LTCC SURFACE MOUNT

Band Pass Filter

BFHK-1202+

50Ω 9.5 to 13.5 GHz

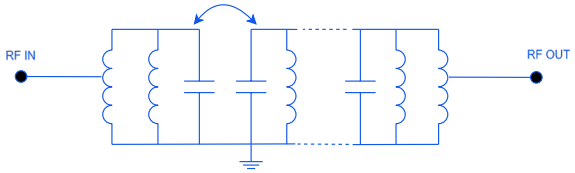
THE BIG DEAL

- Ultra-High Stopband Rejection, 62 dB Typ.
- Surface mountable pick and place standard case style
- Standard small 1812 (4.5x3.2 mm) case style
- High quality distributed filter topology
- Wide rejection band
- Shielded construction preventing filter from de-tuning
- Reduced footprint area by employing LGA (Land Grid Array)
- Suited for very high-volume production
- Protected by US Patents 11,638,370 and 11,744,057



Generic photo used for illustration purposes only

FUNCTIONAL DIAGRAM



APPLICATIONS

- Test & Measurement Equipment
- Satellite Communications
- Aerospace and Defense Signal Conditioning

PRODUCT OVERVIEW

Mini-Circuits' BFHK-1202+ Bandpass Filter delivers precision filtering for upper X-band through the lower edge of Ku-band in a compact, rugged ceramic package. Leveraging proprietary materials science and a distributed design topology, ensures highly repeatable performance for mission-critical designs. The filter provides typical passband loss of 0.85 dB from 9.5 to 13.5 GHz with exceptional stopband rejection of 46 dB from 0.1 to 4.5 GHz and 74 dB through 30 GHz, greatly suppressing interference and harmonics. The BFHK-1202+ is rated for up to 1 W of RF input power and operates over a wide temperature range of -55°C to +125°C, combining reliability and high performance for demanding SATCOM, radar, EW and test environments.

ELECTRICAL SPECIFICATIONS[1,2,3] AT +25°C, Z_0 = 50Ω

Parameter		F#	Frequency (GHz)	Min.	Typ.	Max.	Units
	Center Frequency[4]	-	-	-	11.5	-	GHz
Passband	Insertion Loss	F4-F5	9.5-13.5	-	0.85	1	dB
	Return Loss	F4-F5	9.5-13.5	-	12.3	-	dB
Stopband, Lower	Rejection	DC-F1	0.1-4.5	40	46	-	dB
		F1-F2	4.5-6.5	37	42	-	
		F2-F3	6.5-7	35	42	-	
Stopband, Upper	Rejection	F6-F7	17.5-19	52	62	-	dB
		F7-F8	19-20	66	76	-	
		F8-F9	20-24	66	76	-	
		F9-F10	24-28	70	80	-	
		F10-F11	28-30	64	74	-	

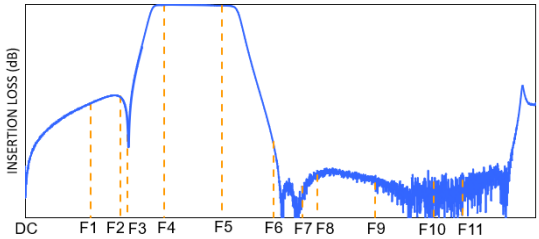
1. Tested on Evaluation Board P/N TB-BFHK-1202C+ with the connector and feedline effects de-embedded using the 2X Thru IEEE P370 method.
2. This filter is bi-directional RF1 and RF2 ports may be interchanged, see S-Parameters for actual performance.
3. This component should not be used as a DC-block. In applications where DC voltage and/or current is present at either the input or output ports, external DC blocking capacitors are required.
4. Typical variation ± 3%

ABSOLUTE MAXIMUM RATINGS[5]

Operating Temperature	-55 °C to +125 °C
Storage Temperature	-55 °C to +125 °C
Input Power[6]	1 W

5. Permanent damage may occur if any of these limits are exceeded.
6. Power rating applies only to signals within the passband. Power rating above +25°C operating temperature decreases linearly to 0.5 W at +125°C.

TYPICAL FREQUENCY RESPONSE



REV. OR
ECO-028573
BFHK-1202+
MCL NY
260212

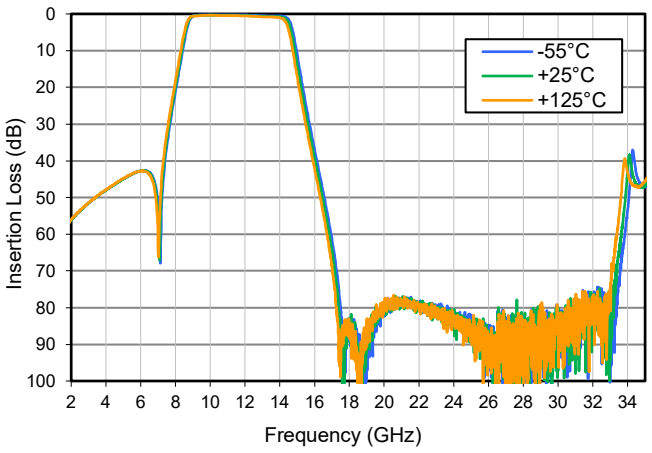
Band Pass Filter

BFHK-1202+

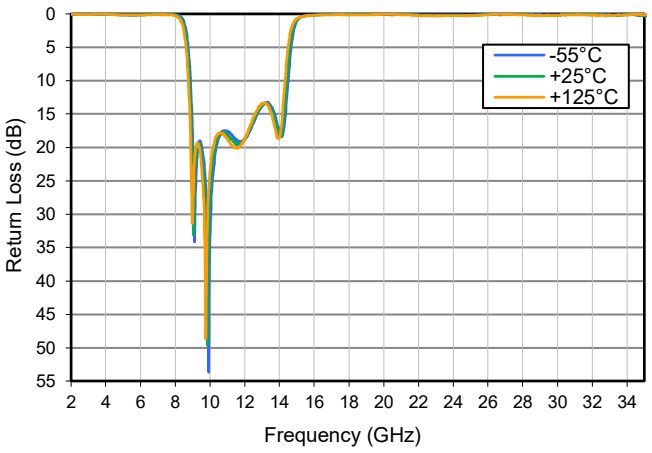
50Ω 9.5 to 13.5 GHz

TYPICAL PERFORMANCE GRAPHS

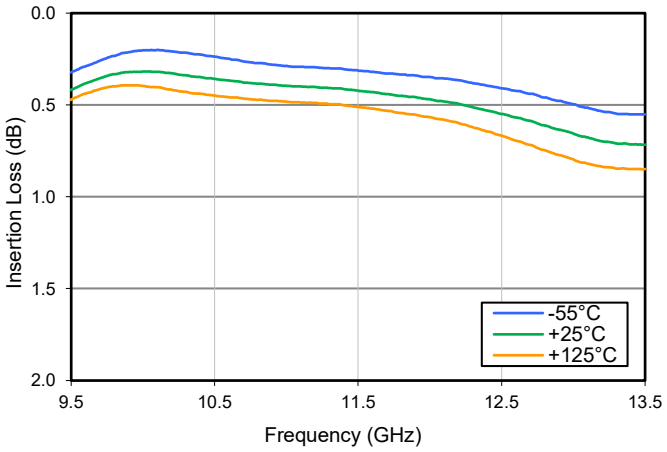
INSERTION LOSS



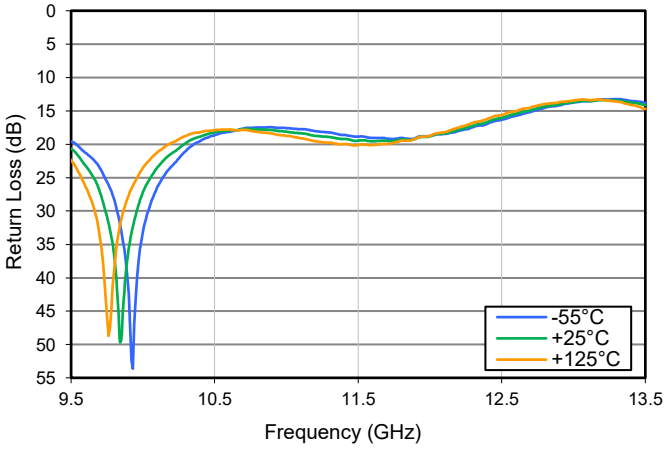
RETURN LOSS



INSERTION LOSS (PASSBAND)



RETURN LOSS (PASSBAND)



LTCC SURFACE MOUNT

Band Pass Filter

BFHK-1202+

50Ω 9.5 to 13.5 GHz

FUNCTIONAL DIAGRAM

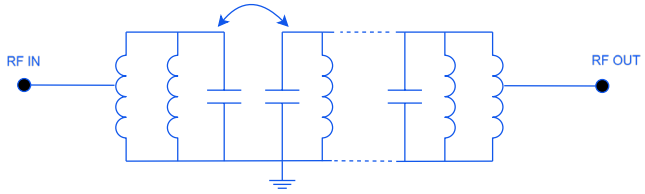
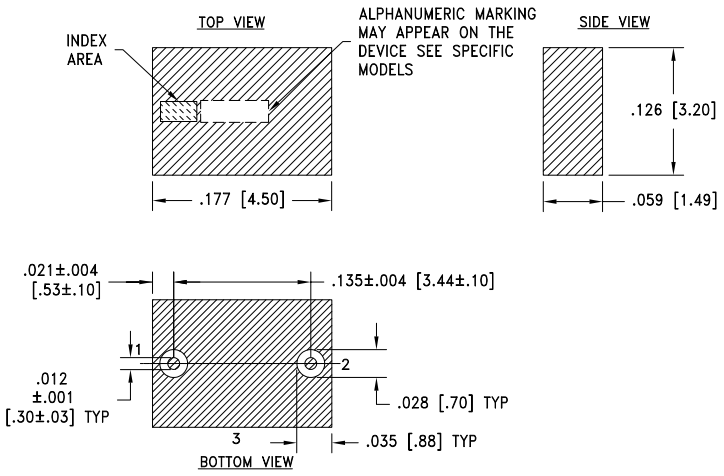


Figure 1. BFHK-1202+ Functional Diagram

PAD DESCRIPTION

Function	Pad Number	Description
RF1[2]	1	Connects to RF Input Port
RF2[2]	2	Connects to RF Output Port
GROUND	3	Connects to Ground on PCB, (See drawing PL-730)

CASE STYLE DRAWING

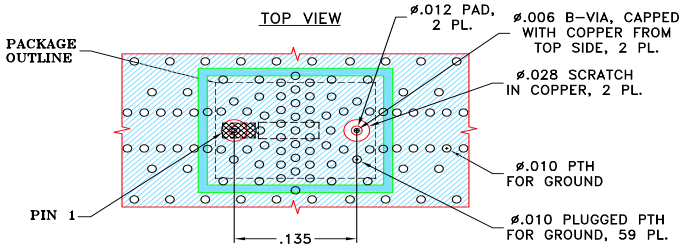


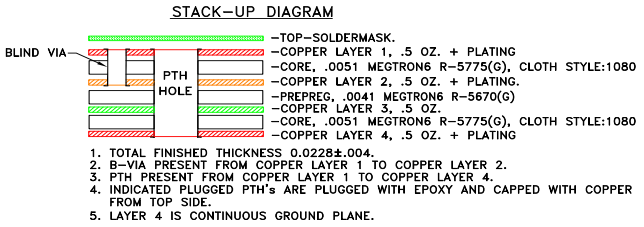
Weight: .126 grams
Dimensions are in inches [mm]. Tolerances: 2 Pl.±.01; 3 Pl. ±.005

PRODUCT MARKING*: F606

*Marking may contain other features or characters for internal lot control.

SUGGESTED PCB LAYOUT: PL-730





NOTES:
1. PCB IS MULTILAYER PCB, SEE STACK-UP DIAGRAM.
2. TRACE WIDTH & GAP PARAMETERS ARE SHOWN FOR MEGTRON6 R-5775(G), CLOTH STYLE:1080 WITH DIELECTRIC THICKNESS .0051; COPPER: 1/2 OZ.+PLATING. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
3. COPPER LAYER 4 OF THE PCB ARE CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

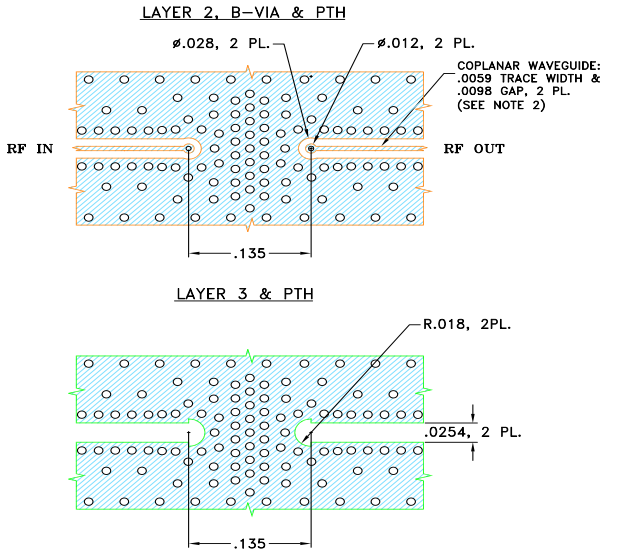


Figure 2. Suggested PCB Layout

Band Pass Filter

BFHK-1202+

50Ω 9.5 to 13.5 GHz

ADDITIONAL DETAILED INFORMATION IS AVAILABLE ON OUR DASHBOARD CLICK HERE

Performance Data & Graphs	Data Graphs S-Parameter (S2P Files) Data Set (.zip file) De-embedded to device pads
Case Style	NM1812C-3 Lead Finish: Tin over Nickel Plating
RoHS/REACH Status	Compliant
Tape and Reel	F77
Suggested Layout for PCB Design	PL-730
Evaluation Board	TB-BFHK-1202C+ Gerber File
Environmental Rating	ENV06T12

NOTES

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.

C. The parts covered by this specification document are subject to Mini-Circuits' standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

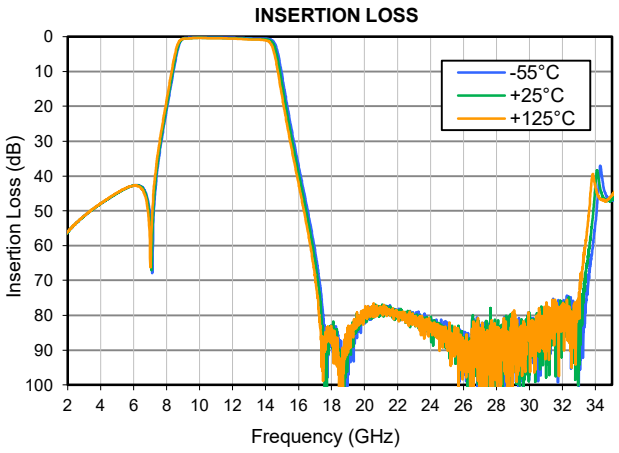
LTCC Bandpass Filter BFHK-1202+

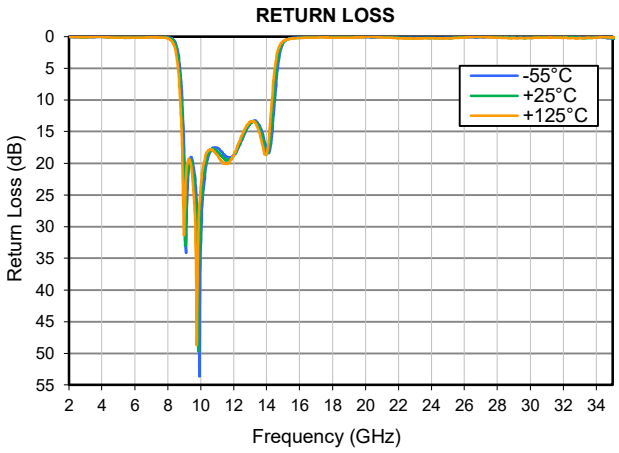
Typical Performance Data

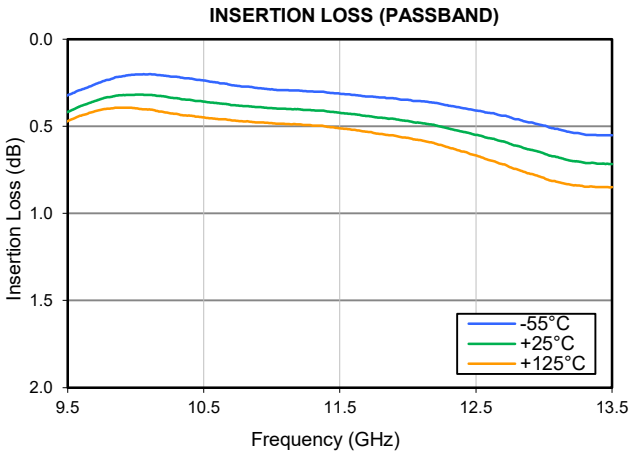
FREQUENCY (GHz)	INSERTION LOSS (dB)			RETURN LOSS (dB)		
	@-55°C	@+25°C	@+125°C	@-55°C	@+25°C	@+125°C
0.50	69.21	68.92	68.64	0.11	0.12	0.14
1.00	62.89	63.04	62.91	0.11	0.13	0.14
2.00	56.21	56.16	56.05	0.03	0.01	0.00
3.00	51.53	51.52	51.51	0.10	0.08	0.09
4.00	48.03	47.94	47.91	0.00	0.03	0.03
5.00	44.96	44.94	44.82	0.12	0.16	0.17
6.00	42.72	42.74	42.75	0.12	0.16	0.18
7.00	51.60	54.56	61.68	0.03	0.07	0.10
8.00	21.19	19.98	18.30	0.10	0.19	0.29
9.00	0.58	0.61	0.64	18.52	25.26	30.30
9.25	0.37	0.49	0.55	21.31	20.03	19.29
9.50	0.32	0.42	0.47	19.58	20.66	22.41
9.75	0.24	0.34	0.40	25.66	30.92	46.09
10.00	0.20	0.32	0.40	33.04	27.15	23.52
10.25	0.21	0.33	0.43	22.10	20.60	19.24
10.50	0.24	0.36	0.45	18.61	18.21	17.89
10.75	0.27	0.38	0.47	17.52	17.72	17.97
11.00	0.29	0.39	0.48	17.55	18.11	18.70
11.25	0.30	0.41	0.49	18.13	18.82	19.67
11.50	0.31	0.42	0.51	18.86	19.46	20.11
11.75	0.33	0.45	0.54	19.17	19.49	19.77
12.00	0.35	0.47	0.56	18.75	18.79	18.72
12.25	0.37	0.50	0.61	17.76	17.54	17.16
12.50	0.41	0.55	0.67	16.35	16.04	15.60
12.75	0.45	0.60	0.73	14.84	14.59	14.19
13.00	0.49	0.66	0.80	13.76	13.69	13.44
13.25	0.54	0.70	0.84	13.28	13.40	13.47
13.50	0.55	0.72	0.85	13.81	14.15	14.73
14.00	0.58	0.79	1.02	17.76	18.33	18.62
15.00	11.09	13.77	17.15	1.06	0.88	0.73
16.00	36.91	39.25	42.17	0.11	0.18	0.22
17.00	61.37	64.49	68.81	0.01	0.07	0.12
18.00	82.82	84.83	86.78	0.01	0.06	0.15
19.00	93.72	85.48	90.71	0.03	0.08	0.14
20.00	79.53	80.23	79.08	0.08	0.01	0.04
21.00	78.44	78.53	79.05	0.05	0.01	0.10
22.00	79.05	80.17	79.77	0.13	0.18	0.27
23.00	80.40	80.48	80.66	0.19	0.25	0.31
24.00	81.15	83.97	83.30	0.16	0.21	0.25
25.00	85.34	86.90	88.24	0.19	0.23	0.28
26.00	84.67	93.00	93.56	0.00	0.04	0.13
27.00	83.37	88.89	86.74	0.07	0.02	0.05
28.00	103.03	83.65	83.60	0.02	0.09	0.16
29.00	93.15	88.39	91.62	0.10	0.17	0.22
30.00	90.52	82.59	82.71	0.13	0.19	0.23

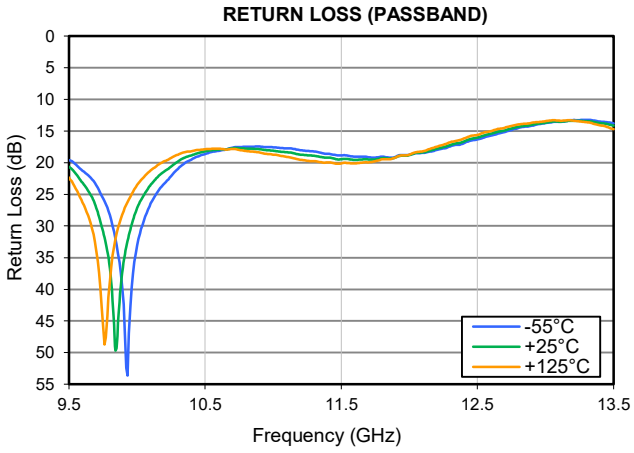
LTCC Band pass Filter BFHK-1202+

Typical Performance Data





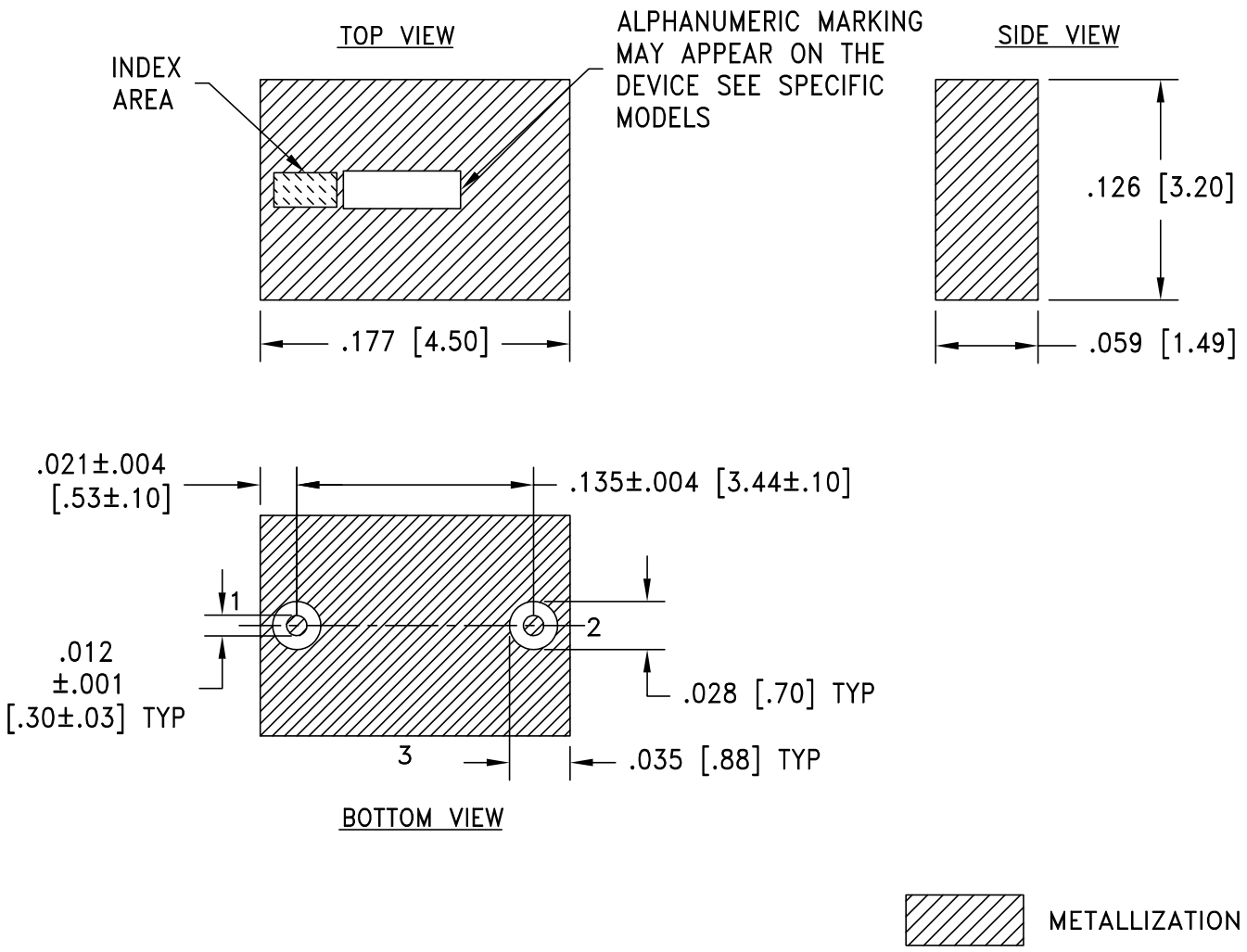




Case Style NM

Outline Dimensions

NM1812C-3



Weight: .126 grams.

Dimensions are in inches [mm]. Tolerances: 2 Pl.±.01; 3 Pl. ±.005 Inches

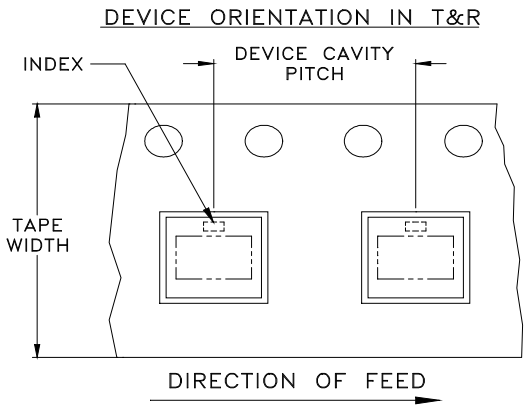
Notes:

1. Case material: Ceramic.
2. Termination Finish: **as shown below or indicated on Data Sheet.**
   For RoHS Case Styles: Tin Plate over Nickel plate. All models, (+) suffix.

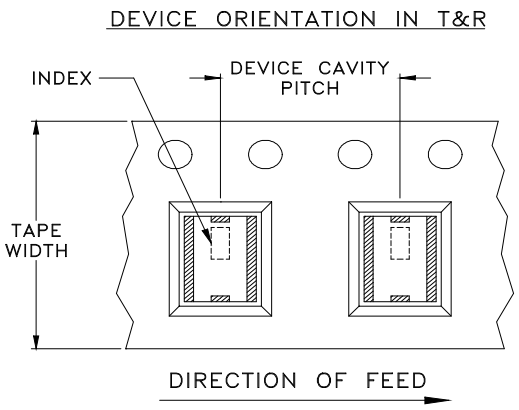
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RF/IF MICROWAVE COMPONENTS

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Tape & Reel Packaging TR-F77



Note: The shape of the pocket may differ



Note: The location and shape of the metallization may differ

Applicable Case Styles
GU1604, GU1804, GU2644, TT1618-2

Applicable Case Styles
MZ4532C, NM1812C, NM1812C-1, NM1812C-2, NM1812C-3, NM1812C-5, NM1812C-6, NM3237 NM1812C-9

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
12	8	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
		13	Standard	2000

Note: Please Consult individual model data sheet to determine device per reel availability.

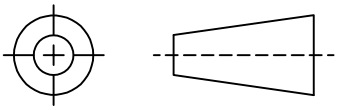
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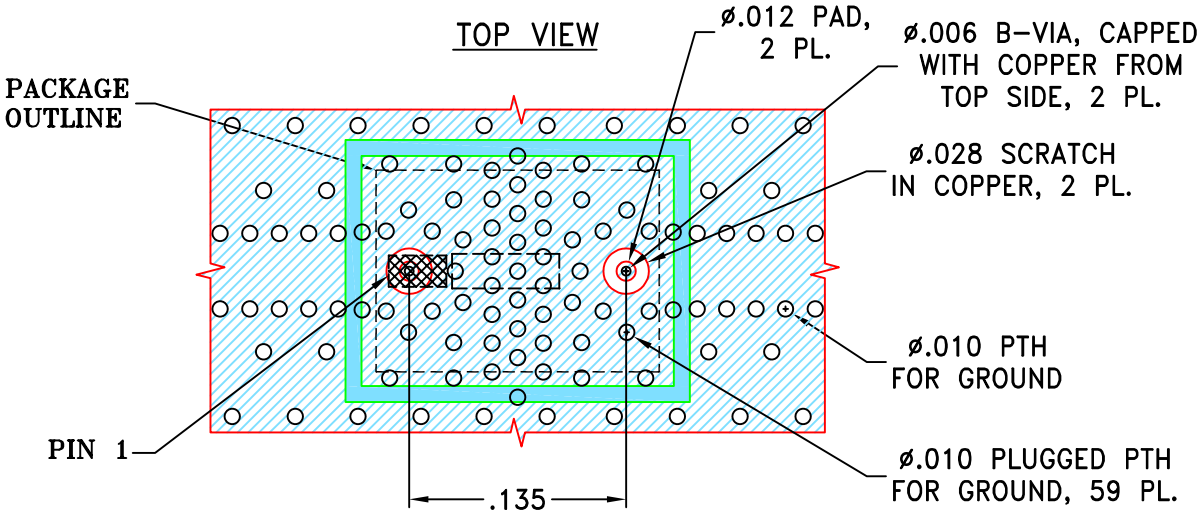
THIRD ANGLE PROJECTION



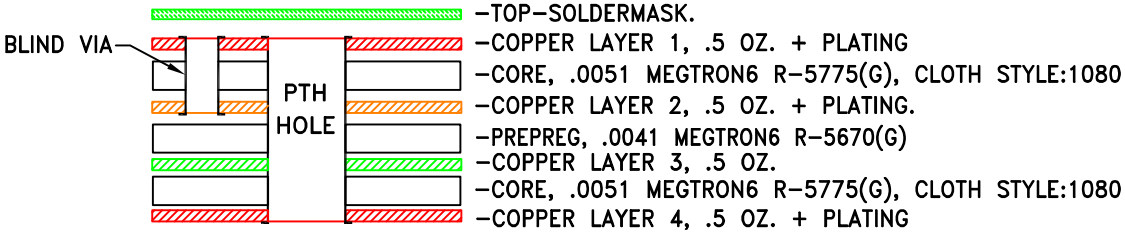
REVISIONS					
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	ECO-013254	NEW RELEASE	05/16/22	ITG	IL
A	ECO-015587	UPDATED STACK-UP DIAGRAM	11/01/22	ITG	IL
B	ECO-020890	ADDED DIMENSIONS	02/16/24	ITG	IL

SUGGESTED MOUNTING CONFIGURATION FOR NM1812C-3 CASE STYLE

TOP VIEW



STACK-UP DIAGRAM



1. TOTAL FINISHED THICKNESS 0.0228±.004.
2. B-VIA PRESENT FROM COPPER LAYER 1 TO COPPER LAYER 2.
3. PTH PRESENT FROM COPPER LAYER 1 TO COPPER LAYER 4.
4. INDICATED PLUGGED PTH's ARE PLUGGED WITH EPOXY AND CAPPED WITH COPPER FROM TOP SIDE.
5. LAYER 4 IS CONTINUOUS GROUND PLANE.

NOTES:

1. PCB IS MULTILAYER PCB, SEE STACK-UP DIAGRAM.
2. TRACE WIDTH & GAP PARAMETERS ARE SHOWN FOR MEGTRON6 R-5775(G), CLOTH STYLE:1080 WITH DIELECTRIC THICKNESS .0051; COPPER: 1/2 OZ.+PLATING. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
3. COPPER LAYER 4 OF THE PCB ARE CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	ITG	05/16/22
TOLERANCES ON:	CHECKED	GF	05/16/22
2 PL DECIMALS ±	APPROVED	IL	05/16/22
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			

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ASHEETA1.DWG REV:A DATE:01/12/95

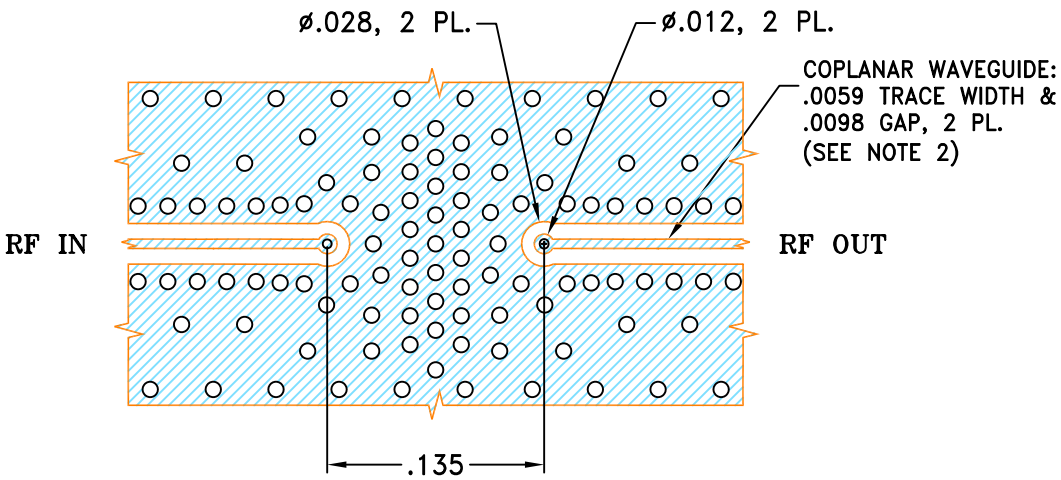
Mini-Circuits® 13 Neptune Avenue Brooklyn NY 11235

PL, NM1812C-3, TB-1239

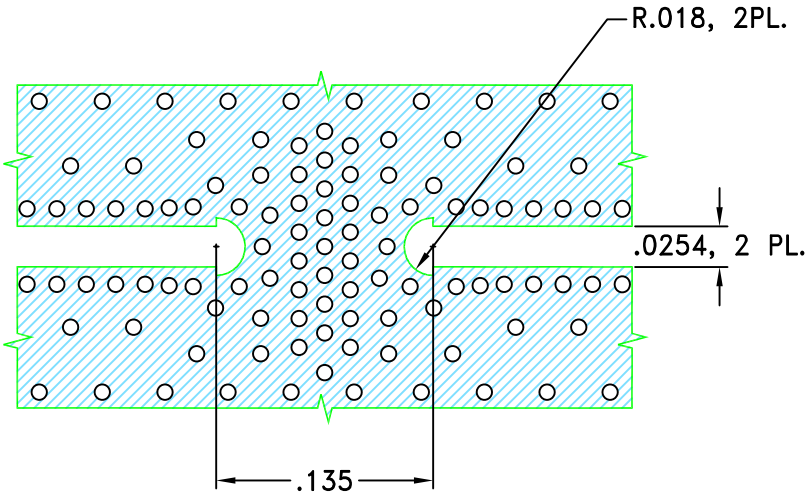
SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-730	B

FILE:	SCALE:	SHEET:
98PL730	8:1	1 OF 2

LAYER 2, B-VIA & PTH



LAYER 3 & PTH



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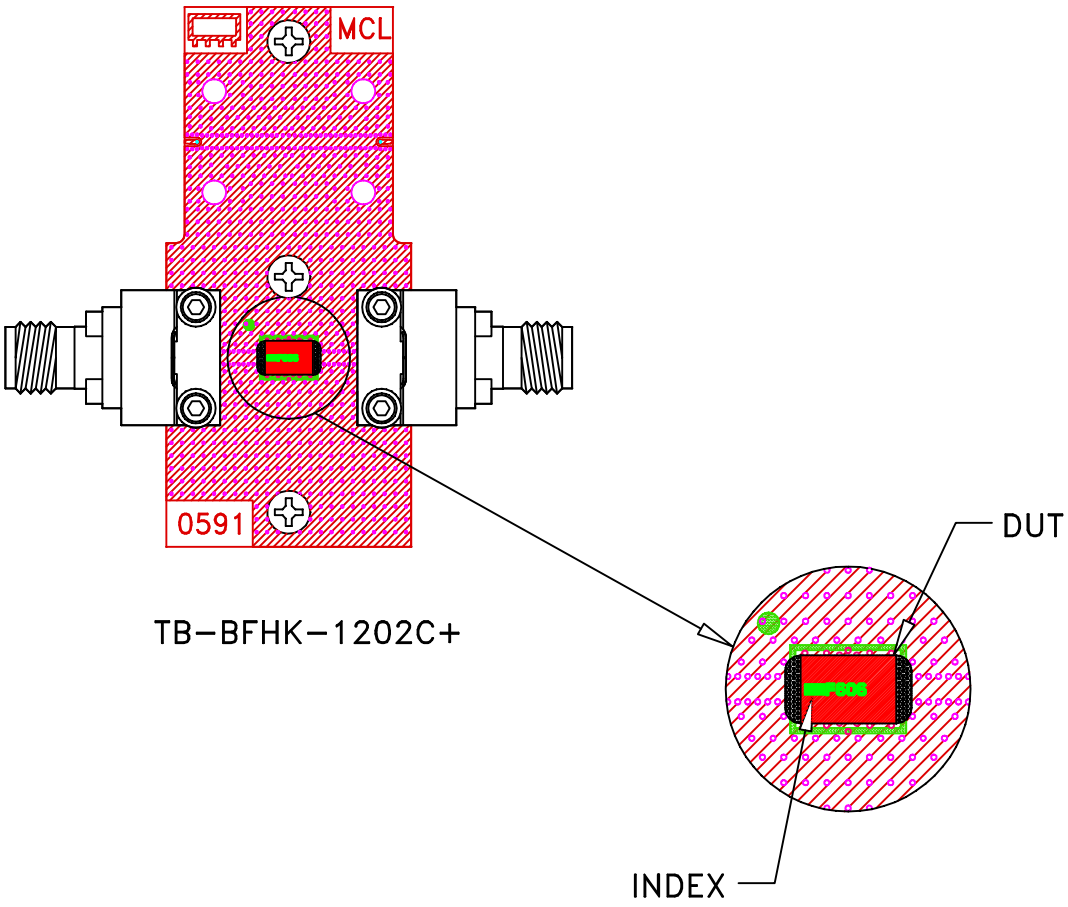
ASHEETA2.DWG REV:A DATE: 01/12/94

ALL DIMENSIONS ARE IN INCHES EXCEPT OTHERWISE SPECIFIED

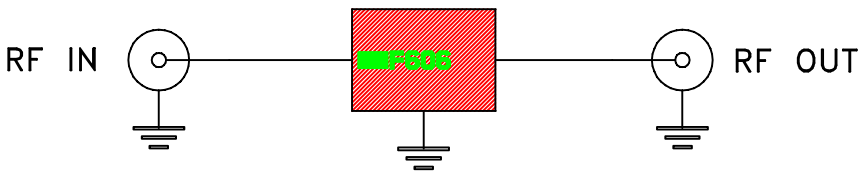
SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-730	B

FILE:	SCALE:	SHEET:
98PL730	8:1	2 OF 2

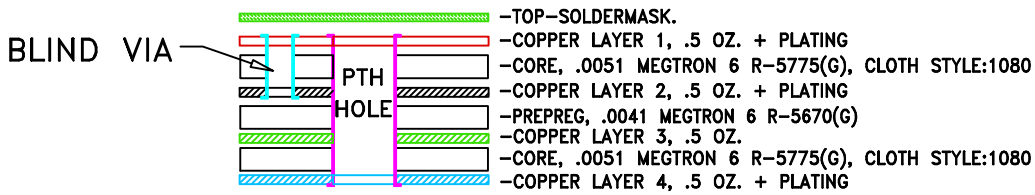
Evaluation Board and Circuit



TB-BFHK-1202C+



Schematic Diagram



STACK-UP DIAGRAM

Notes:

1. 2.92 mm Female End Launch Connector.
2. PCB Material: Megtron 6 R5775(N).
   Dielectric Constant=3.6.
3. Total finished thickness .023".

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Environmental Specifications ENV06T8

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Thermal Cycling	-55 to 125°C, 100 cycles, Dwell Time 15 minutes.	MIL-STD-202, Method 107, Condition A-3
Mechanical Shock	50g, 11ms half-sine, 18 shocks applied each to 3 axes	MIL-STD-202 Method 213, Condition A
Vibration	10-2000Hz sine, 20g, 12 cycles applied each to 3 axes	MIL-STD-202, Method 204, Condition D
Constant Acceleration	30Kg, Y1 Direction	MIL-STD-883, Method 2001, Condition E
Humidity	85°C, 90-95% Relative Humidity, 250hours	
Solderability	10X / 30X Magnification	J-STD-002C Test S, J-STD-002C Test S1
High Temp Storage	125°C, 250 hours	

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